



Title: "Molded Flip Chip Package"
Inventors: Kumamoto et al. Application No.: 10/051,980 Attorney Docket No.: 42390P9482D
Blakely, Sokoloff, Taylor & Zafman 303-740-1980

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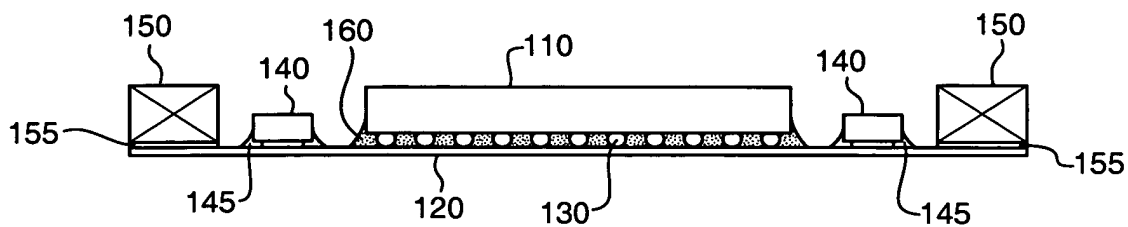


FIG. 1
PRIOR ART



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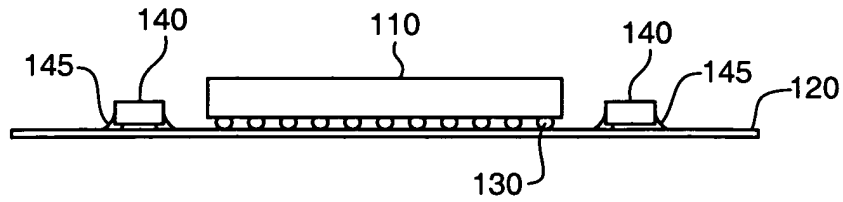


FIG. 2A

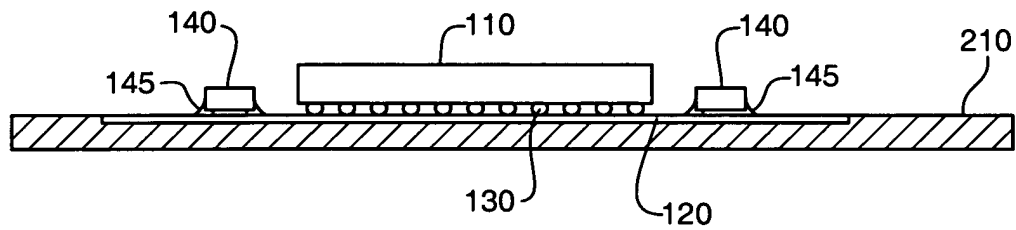


FIG. 2B

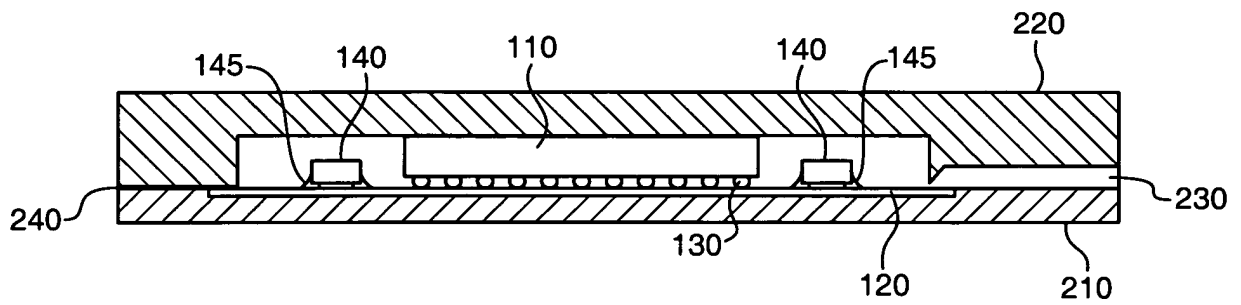


FIG. 2C



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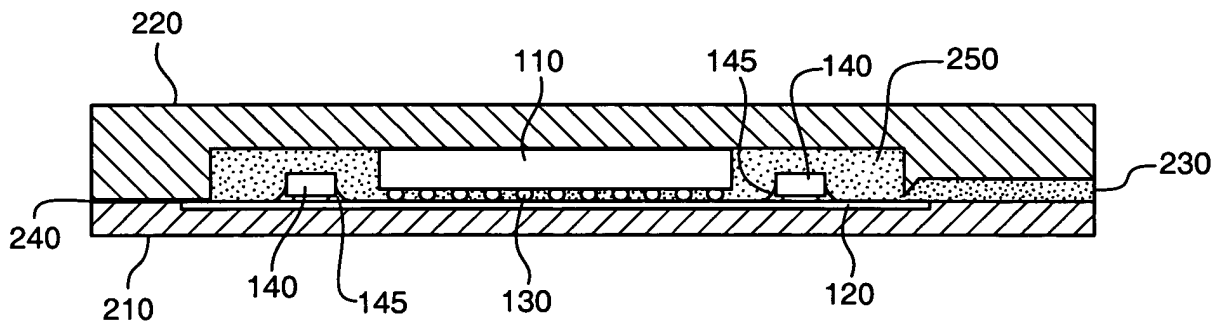


FIG. 2D

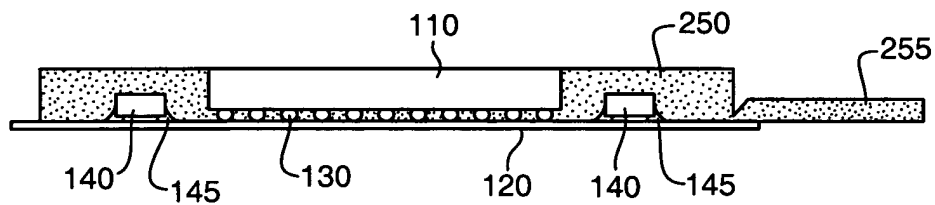


FIG. 2E

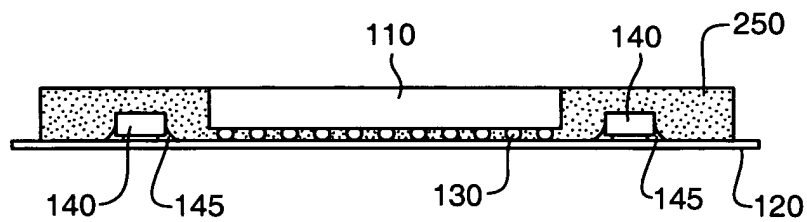


FIG. 2F



FIG. 3

